TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK2542

Switching Regulator Applications

• 4-V gate drive

• Low drain–source ON-resistance : RDS (ON) = 0.75 Ω (typ.)

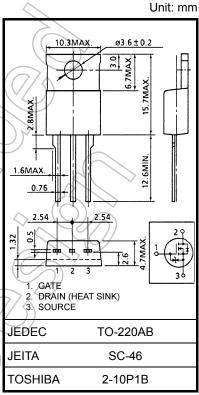
• High forward transfer admittance : $|Y_{fs}| = 7.0 \text{ S (typ.)}$

• Low leakage current : IDSS = 100 μA (max) (VDS = 500 V)

• Enhancement mode : $V_{th} = 2.0 \text{ to } 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteris	etics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	500	(V)
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	500	V
Gate-source voltage		V_{GSS}	±30	V
Drain current	DC (Note 1)	ΙD	8	Α
	Pulse (Note 1)	I_{DP}	32	Α
Drain power dissipation	r (Tc = 25°C)	P _D	80	W
Single pulse avalanche	energy (Note 2)	EAS	312	mJ
Avalanche current		I _{AR})) 8	Α
Repetitive avalanche e	nergy (Note 3)	EAR	8	mJ
Channel temperature		(T _{ch})	150	//,c
Storage temperature ra	inge	√T _{stg}	-55 to 150	°C



Weight: 2.0 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th} (ch-c)	1.56	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.3	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 8.3 mH, R_G = 25 Ω , I_{AR} = 8 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

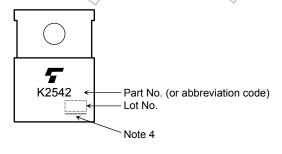
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	7	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	/	_	V
Gate threshold v	voltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0))~	4.0	V
Drain-source O	N-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 4 A) 	0.75	0.85	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 4 A	3.5	7.0	_	S
Input capacitano	e	C _{iss}			1300	_	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	130	_	pF
Output capacita	nce	Coss		_	400	_	
Switching time	Rise time	t _r	V_{CS} $I_D = 4A$	- (26	7	
	Turn-on time	t _{on}	CI RL		45) _	ne
	Fall time	t _f	$V_{DD} = 30 \Omega$	9	40	-	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm w} = 10 \mu \rm s$) –	140	ı	
Total gate charg plus gate-drain)		Qg			30	ı	
Gate-source ch	arge	Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	_	17	_	nC
Gate-drain ("mil	ler") charge	Qgd		_	13	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	-	_	_	8	Α
Pulse drain reverse current (Note 1)	I _{DRP}	-	_	_	32	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 8 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 8 A, V _{GS} = 0 V dI _{DR} / dt = 100 A / μs		1200		ns
Reverse recovery charge	Qrr		_	10	_	μC

Marking

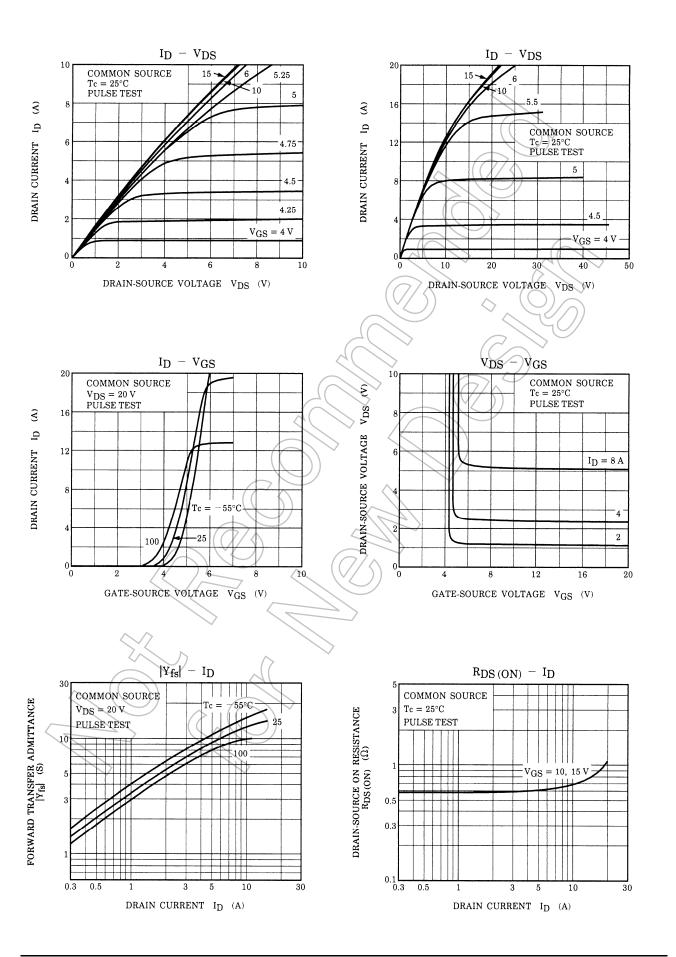


Note 4: A line under a Lot No. identifies the indication of product Labels.

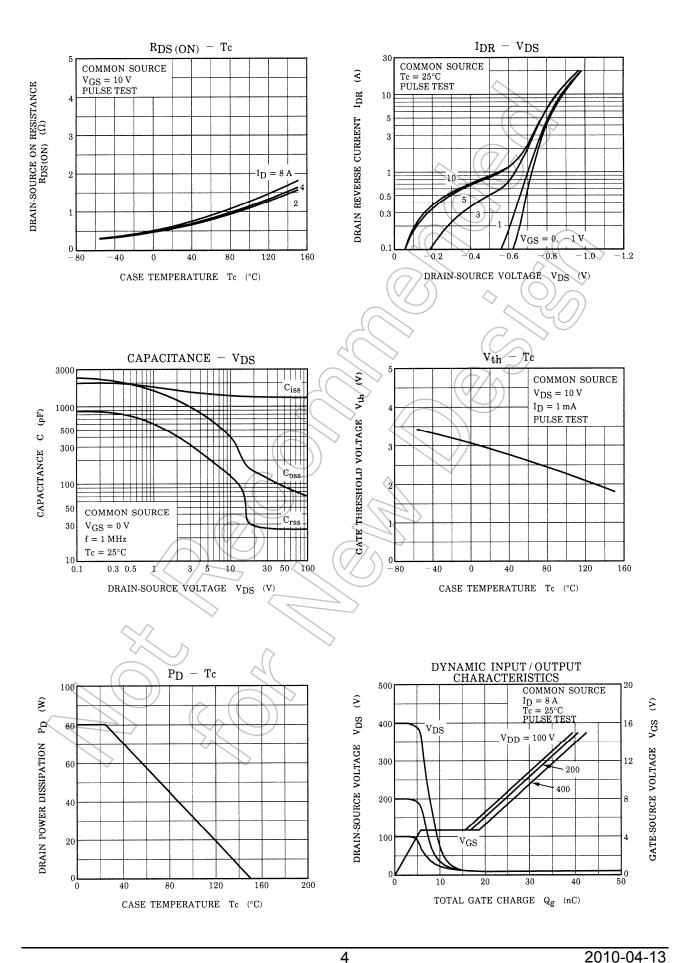
Not underlined: [[Pb]]/INCLUDES > MCV

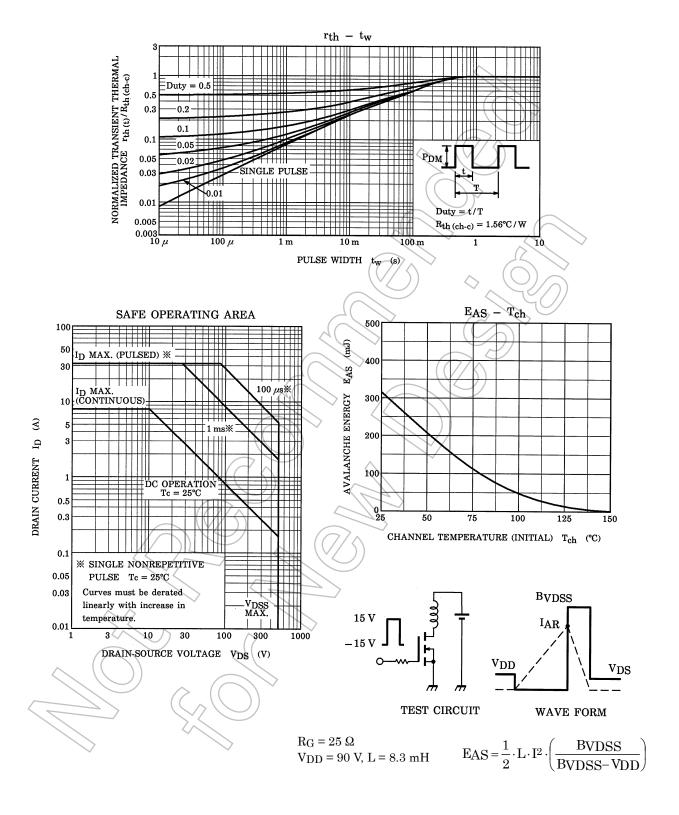
 $\label{thm:lined:general} \mbox{Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]}$

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